

Vishay

RoHS

COMPLIANT

20 x 2 Character OLED

FEATURES

• Type: character

• Display format: 20 x 2 characters

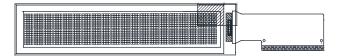
Built-in controller: SSD1311

Duty cycle: 1/16+5 V power supplyInterface: 6800

With polarizer

Material categorization: for definitions of compliance

please see www.vishay.com/doc?99912



MECHANICAL DATA								
ITEM	STANDARD VALUE	UNIT						
Module dimension	84.5 x 19.28 x 2.17							
Viewing area	75.52 x 13.52							
Active area	73.52 x 11.52							
Dot size	0.62 x 0.67	mm						
Dot pitch	0.65 x 0.70	mm						
Mounting hole	n/a							
Character size	3.22 x 5.57							
Character pitch	3.70 x 5.95							

ABSOLUTE MAXIMUM RATINGS											
ITEM	SYMBOL	STANDAF	RD VALUE	UNIT							
I I EIVI	STIVIBUL	MIN.	MAX.	UNII							
Supply voltage for logic	V _{DD} to V _{SS}	-0.3	6.0	V							
Input voltage	VI	-0.3	V_{DD}	V							
Operating temperature	T _{OP}	-40	+80	°C							
Storage temperature	T _{STG}	-40	+80	C							

Notes

- All the above voltages are on the basis of "V_{SS} = 0 V"
- When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate

ELECTRICAL CHARACTERISTICS											
ITEA	CVMPOL	COMPITION	ST	ANDARD VAL	.UE	LINUT					
ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT					
Supply voltage for logic	V _{DD} to V _{SS}	-	4.8	5.0	5.3						
Supply voltage for display	V _{CC}	=	8	9	10						
Input high voltage	V _{IH}	=	0.8 V _{DD}	-	-	V					
Input low voltage	V _{IL}	-	-	-	0.2 V _{DD}	7 V					
Output high voltage	V _{OH}	$I_{OH} = -0.5 \text{ mA}$	0.9 V _{DD}	-	-						
Output low voltage	V _{OL}	$I_{OL} = 0.5 \text{ mA}$	-	-	0.1 V _{DD}						
50 % check board operating current	I _{CC}	V _{CC} = 9 V	14	15	18	mA					

Note

• When you use 5 V for V_{DD} please do not use 3 V or 3.3 V for logic I/O this will cause module does not work

OPTIONS				
		EMITTING COLOR		
YELLOW	GREEN	RED	BLUE	WHITE
Yes	-	-	-	-

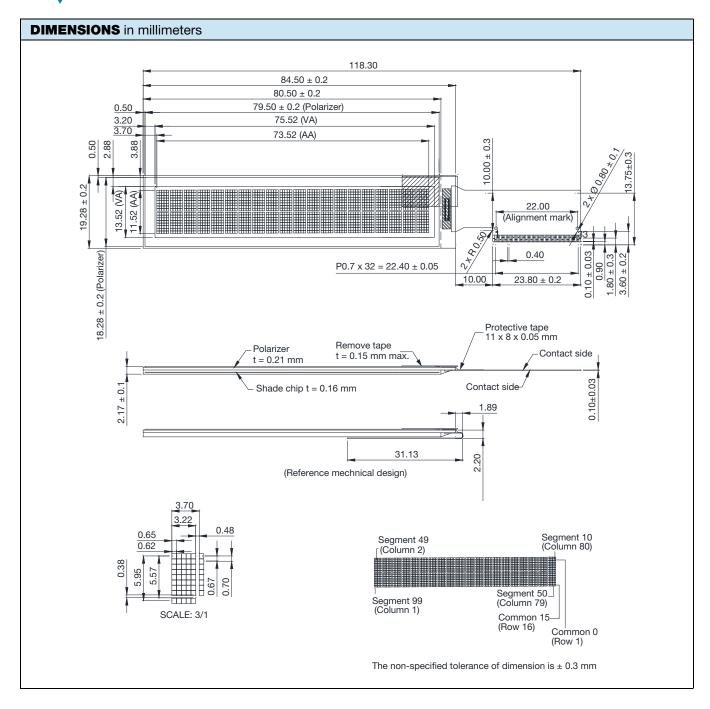
Revision: 10-Aug-17 **1** Document Number: 37818 For technical questions, contact: displays@vishay.com



	ACE PIN		IN .						
PIN NO.	SYMBOL	PIN TYPE	DESCRIPTION						
1	NC	-	No connection						
2	V _{SL}	Р	This is segment voltage (output low level) reference pin. When external V_{SL} is not used, this pin should be left open. When external V_{SL} is used, connect v resistor and diode to ground (details depend on application).						
3	V_{SS}	Р	Ground pin. It must be	connected to external ground.					
4	REG V _{DD}	I	Internal V_{DD} regulator selection pin in 5 V I/O application mode. When this pin is pulle internal V_{DD} regulator is enabled (5 V I/O application). When this pin is pulled "low", internal V_{DD} regulator is disabled (low voltage I/O application).						
			This pin is used to deter COM scan direction	rmine the common output scanning direction.					
			SHLC	COM scan direction					
_	SHLC		0	COM0 to COM31 (normal)					
5	SHLC	I	1	COM31 to COM0 (reverse)					
			Notes • 0 is connected to V _{SS} • 1 is connected to V _{DD}	N/O					
			This pin is used to chan driver. SEG scan directi	ge the mapping between the display data column address and the segment on					
			SHLS	SEG direction					
6	SHLS	1	1	SEG0 to SEG99 (normal)					
O	SHLS	l l	0	SEG99 to SEG0 (reverse)					
			Notes • 0 is connected to V _{SS} • 1 is connected to V _{DD}	N/O					
7	V _{DD}	Р	In LV I/O application (in In 5 V I/O application (in	ogic operation. V_{DD} can be supplied externally or regulated internally. ternal V_{DD} is disabled), this is a power input pin. atternal V_{DD} is enabled), V_{DD} is regulated internally from $V_{DDI/O}$. connected between V_{DD} and V_{SS} under all circumstances.					
8	V _{DDI/O}	Р		oply and power supply for interface logic level in both low voltage I/O and nould match with the MCU interface voltage level and must be connected to					
9	BS0		MCU bus interface sele	ection pins. Select appropriate logic setting as described in the following					
10	BS1			60 are pin select. Bus Interface selection.					
			BS [2:0]	Interface					
			000	Serial interface					
			001	Invalid					
			010	I ² C					
		I	011	Invalid					
11	BS2		100	8-bit 6800 parallel					
			101	4-bit 6800 parallel					
			110	8-bit 8080 parallel					
			111	4-bit 8080 parallel					
			Notes	<u>. </u>					
			 0 is connected to V_{SS} 						
			 1 is connected to V_{DD} 	.,, 0					
12	GPIO	I/O	· · · · · · · · · · · · · · · · · · ·	refer to OLED command DCh.					
13	CS#	I	only when CS# is pulled In I ² C mode, this pin mu	ust be connected to V _{SS} .					
14	RES#	I		This pin is reset signal input. When the pin is pulled "low", initialization of the chip is executed. Keep this pin pull "high" during					



INTERF	ACE PIN	FUNCTIO	N					
PIN NO.	SYMBOL	PIN TYPE		[DESCRIPTION			
15	D / C#	I	This pin is data / command control pin connecting to the MCU. When the pin is pulled "high", the data at D [7:0] will be interpreted as data. When the pin is pulled "low", the data at D [7:0] will be transferred to a command register. In I ² C mode, this pin acts as SA0 for slave address selection. When serial interface is selected, this pin must be connected to V _{SS} .					
16	R / W# (WR#)	I	This pin is read / write control input pin connecting to the MCU interface. When 6800 interface mode is selected, this pin will be used as read / write (R / W#) selection input. Read mode will be carried out when this pin is pulled "high" and write mode when "low". When 8080 interface mode is selected, this pin will be the write (WR#) input. Data write operation is initiated when this pin is pulled "low" and the chip is selected. When serial or I ² C interface is selected, this pin must be connected to V _{SS} .					
17	E (RD#)	ı	operation is initiate When 8080 interfa initiated when this	ce mode is selected, the ed when this pin is pulled ce mode is selected, the pin is pulled "low" and the	d "high" and the chip is sele his pin receives the read (RI	D#) signal. Read operation is		
18	D0							
19	D1		Those pine are hi	directional data bus con	nosting to the MCII data by			
20	D2		•	ecommended to tie "low	necting to the MCU data bu	JS.		
21	D3	I/O	When serial interfa	ce mode is selected, D0) will be the serial clock inpu	ıt: SCLK; D1 will be the serial		
22	D4	1/0		d D2 will be the serial da		004 004		
23	D5		When I ² C mode i	is selected, D2, D1 sh) is the serial clock input	ould be tied together and	I serve as SDA _{out} , SDA _{in} in		
24	D6		apphoanon and 20		,, 332.			
25	D7							
26	I _{REF}	1			rence pin. I _{REF} is supplied ex aintain current of around 15	xternally. A resistor should be μA.		
27	ROM0			M1 and ROM0 are pin s	OM; select appropriate logi select as shown in below tal ROM	ic setting as described in the ble.		
			0	0	Α			
		I	0	1	В			
			1	0	С			
			1	1	S / W selectable			
28	ROM1		Notes0 is connected to1 is connected to					
			This pin is used to Character RAM sel		mber of character generator	r.		
29	OPR0		OPR1	OPR0	CGROM	CGRAM		
			1	1	256	0		
			0	1	248	8		
		'	1	0	250	6		
			0	0	240	8		
30	OPR1		Notes • 0 is connected to • 1 is connected to					
31	V _{COMH}	Р		ected voltage level. A ca supply is allowed to co		ed between this pin and V_{SS} .		
32	V _{CC}	Р		panel driving voltage. Thi al high voltage source.	is is also the most positive p	power voltage supply pin. It is		
33	NC	_	No connection					





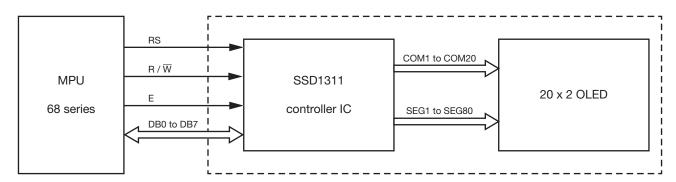
MODULE CLAS	SSIFICATION INFORMA	ATION						
OLED -	020 O 002 A							
1	2 3 4 5	6 7 8 9 10 11 12 13						
1 2	Brand Horizontal format	Vishay Intertechnology, Inc. 20 characters						
3	Display type	H: graphic type N: character type O: COG type Y: tab type						
4	Vertical format	2 lines						
5	Serials code	A						
6	Emitting color	A: amber B: blue C: full color G: green L: yellow R: red W: white Y: yellow green						
7	Polarizer	N: without polarizer P: with polarizer						
8	Display mode	A: active matrix P: passive matrix						
9	Driver voltage	3: 3.0 V to 3.3 V 5: 5.0 V						
10	Touch panel	N: without touch panel T: with touch panel						
11	Products type	0: standard 1: sunlight readable 2: transparent OLED (TOLED) 3: flexible OLED 4: OLED for lighting						
12	Product grades	0: standard (A level) 2: B level 3: C level 4: high class (AA level) 5: customer offerings						
13	Serial number	Application serial number (000 to ZZZ)						



Vishay

GENERAL SPECIFICATIONS							
ITEM	DIMENSION	UNIT					
Number of characters	20 characters x 2 lines						
Module dimension	84.5 x 19.28 x 2.17	mm					
View area	75.52 x 13.52	mm					
Active area	73.52 x 11.52	mm					
Dot size	0.62 x 0.67	mm					
Dot pitch	0.65 x 0.70	mm					
Character size	3.22 x 5.57	mm					
Character pitch	3.70 x 5.95	mm					
Panel type	OLED, yellow						
Duty	1/16						
IC	SSD1311						

FUNCTION BLOCK DIAGRAM

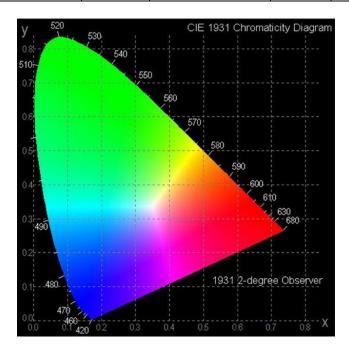


Display position	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
DD RAM address	00	01	02	03	04	05	06	07	08	09	0A	0B	OC	0D	0E	0F	10	11	12	13
DD RAM address	40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F	50	51	52	53



Vishay

OPTICAL CHARACTERISTICS										
ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT				
View angle	(V)θ		160	-	-	dog				
View angle	(H)φ		160	=	-	deg				
Contrast ratio	CR	Dark	2000 : 1	=	-	-				
Response time	t _{rise}		-	10	-	μs				
nesponse time	t _{fall}		-	10	-	μs				
Display with 50 % check board brightness			120	130	-	cd/m ²				
CIE _x (yellow)	(CIE1931)		0.45	0.47	0.49					
CIE _y (yellow)	(CIE1931)	_	0.48	0.50	0.52					



OLED LIFETIME			
ITEM	CONDITIONS	MIN.	TYP.
Operating life time	T _A = 25 °C, initial 50 % check board brightness typical value	50 000 h	-

Notes

- Life time is defined the amount of time when the luminance has decayed to < 50 % of the initial value
- This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (PDF) for the product under normal use conditions
- Screen saving mode will extend OLED lifetime



Vishay

RELABILITY		
ENVIRONMENTAL TEST		
TEST ITEM	CONTENT OF TEST	TEST CONDITION
High temperature storage	Endurance test applying the high storage temperature for a long time	80 °C, 240 h
Low temperature storage	Endurance test applying the low storage temperature for a long time	-40 °C, 240 h
High temperature operation	Endurance test applying the electric stress (voltage and current) and the thermal stress to the element for a long time	80 °C, 240 h
Low temperature operation	Endurance test applying the electric stress under low temperature for a long time	-40 °C, 240 h
High temperature / humidity storage	Endurance test applying the high temperature and high humidity storage for a long time	60 °C, 90 % RH, 240 h
Temperature cycle	Endurance test applying the low and high temperature cycle -40 °C 25 °C 80 °C 30 min 5 min 30 min	-40 °C / 80 °C, 100 cycles
	1 cycle	
MECHANICAL TEST		
Vibration test	Endurance test applying the vibration during transportation and using	10 Hz to 22 Hz for 1.5 mm peak-to-peak, 22 Hz to 500 Hz for 1.5 <i>g</i> , total 0.5 h
Shock test	Constructional and mechanical endurance test applying the shock during transportation	50 <i>g</i> half sin wave 11 ms, 3 times of each direction
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air	115 mbar, 40 h
OTHERS		
Static electricity test	Endurance test applying the electric stress to the terminal	$V_S = \pm 600$ V (contact), ± 800 V (air), $R_S = 330$ Ω , $C_S = 150$ pF, 10 times

Note

Supply voltage for OLED system = operating voltage at 25 °C

TEST AND MEASUREMENT CONDITIONS

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hours prior to conducting the failure test at $23 \,^{\circ}\text{C} \pm 5 \,^{\circ}\text{C}$, $55 \,^{\circ}\text{C} \pm 15 \,^{\circ}\text{RH}$
- 2. All-pixels-on is used as operation test pattern
- 3. The degradation of polarizer are ignored for high temperature storage, high temperature / humidity storage, temperature cycle

EVALUATION CRITERIA

- 4. The function test is OK
- 5. No observable defects
- 6. Luminance: > 50 % of initial value
- 7. Current consumption: within \pm 50 % of initial value

APPENDIX: RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.



INSI	PECTION SPECII	FICATION				
NO.	ITEM		CRITERIO	N		AQL
01	Electrical testing	 1.1 Missing vertical, horizontal segment, segment contrast defect 1.2 Missing character, dot or icon 1.3 Display malfunction 1.4 No function or no display 				
		1.5 Current consumption exceeds product specifications1.6 OLED viewing angle defect1.7 Mixed product types				0.65
02	Black or white spots on OLED (display only)	 1.8 Contrast defect 2.1 White and black spots on display ≤ 0.25 mm, no more than three white or black spots present 2.2 Densely spaced: no more than two spots or lines within 3 mm 			2.5	
		3.1 Round type: as following	drawing	SIZE	ACCEPTABLE QTY	
		$\Phi = (x + y) / 2$	3	Φ ≤ 0.10	Accept no dense	
		→ x <u>← ↓</u>		0.10 < Φ ≤ 0.20	2	2.5
		У		0.20 < Φ ≤ 0.25	1	
	OLED black spots,	<u> </u>		0.25 < Φ	0	
03	white spots, contamination					
	(non-display)	3.2 Line type	LENGTH	WIDTH	ACCEPTABLE QTY	2.5
		(as following drawing)	-	W ≤ 0.02	Accept no dense	
			L ≤ 3.0	$0.02 < W \le 0.03$	2	
			L ≤ 2.5	$0.03 < W \le 0.05$	2	
			-	0.05 < W	As round type	
	Polarizer bubbles	SIZE Φ ACCEPTABLE QTY				
				Accept no dense		
04		If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction. $ 0.20 < \Phi \le 0.50 $ 3 $ 0.50 < \Phi \le 1.00 $ 2			2.5	
		1.00 < Φ 0		-		
				Total QTY	3	
05	Scratches	Follow no. 3 OLED black spots, white spots, contamination				
		Symbols: x: chip length k: seal width l: electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surface an	y: chip width t: glass thickness d crack between pane	əls:	z: chip thickness a: OLED side length	
	i					i
06	Chipped glass	z: chip thickness $z \le 1/2 t$	y: chip width Not over viewing a	x y z	x: chip length x ≤ 1/8 a	2.5
06	Chipped glass	z: chip thickness		x y z		2.5



	PECTION SPEC	IFICATION			1	
NO.	ITEM		CRITERION		AQL	
06	Chipped glass	6.1.2 Corner crack:	X Z Y		2.5	
		z: chip thickness	y: chip width	x: chip length		
		z ≤ 1/2 t	Not over viewing area	x ≤ 1/8 a		
		1/2 t < z ≤ 2 t	Not exceed 1/3 k	x ≤ 1/8 a		
		Note	s, x is total length of each chip		1	
		Symbols: x: chip length k: seal width l: electrode pad length 6.2 Protrusion over termin	y: chip width t: glass thickness	z: chip thickness a: OLED side length		
			× ×	z		
		y: chip width	x: chip length	z: chip thickness		
		y ≤ 0.5 mm	x ≤ 1/8 a	0 < z ≤ t		
		6.2.2 Non-conductive portion				
06	Glass crack	y 1 _z		, , , , , , , , , , , , , , , , , , ,	2.5	
		y: chip width	x: chip length	z: chip thickness		
		y ≤ l	x ≤ 1/8 a	0 < z ≤ t		
		according to electrode terr	sealed by the customer, the alignment			
			ack is not acceptable		2.	





INSPECTION SPECIFICATION				
NO.	ITEM	CRITERION	AQL	
		8.1 Illumination source flickers when lit	0.65	
08	Backlight elements	8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards	2.5	
		8.3 Backlight does not light or color wrong	0.65	
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination	2.5	
03	Dezei	9.2 Bezel must comply with job specifications	0.65	
		10.1 COB seal may not have pinholes larger than 0.2 mm or contamination	2.5	
		10.2 COB seal surface may not have pinholes through to the IC	2.5	
		10.3 The height of the COB should not exceed the height indicated in the assembly diagram	0.65	
	PCB, COB	10.4 There may not be more than 2 mm of sealant outside the seal area on the PCB. And there should be no more than three places	2.5	
10		10.5 No oxidation or contamination PCB terminals	2.5	
		10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts	0.65	
		10.7 The jumper on the PCB should conform to the product characteristic chart	0.65	
		10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down	2.5	
		11.1 No un-melted solder paste may be present on the PCB	2.5	
11	Soldering	11.2 No cold solder joints, missing solder connections, oxidation or icicle	2.5	
''	Soldering	11.3 No residue or solder balls on PCB	2.5	
		11.4 No short circuits in components on PCB	0.65	
		12.1 No oxidation, contamination, curves or, bends on interface pin (OLB) of TCP	2.5	
		12.2 No cracks on interface pin (OLB) of TCP	0.65	
		12.3 No contamination, solder residue or solder balls on product	2.5	
		12.4 The IC on the TCP may not be damaged, circuits	2.5	
	General appearance	12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever	2.5	
12		12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color	2.5	
		12.7 Sealant on top of the ITO circuit has not hardened	2.5	
		12.8 Pin type must match type in specification sheet	0.65	
		12.9 OLED pin loose or missing pins	0.65	
		12.10 Product packaging must the same as specified on packaging specification sheet	0.65	
		12.11 Product dimension and structure must conform to product specification sheet	0.65	



CHECK ITEM	CLASSIFICATION	CRITERIA
No display	Major	
Missing line	Major	
IVIISSIII Y III IE		
Pixel short	Major	
Darker short	Major	
Wrong display	Major	
Un-uniform	Major	
B/A x 100 % < 70 % A/C x 100 % < 70 %		A Normal B Dark pixel C Light pixel

Vishay

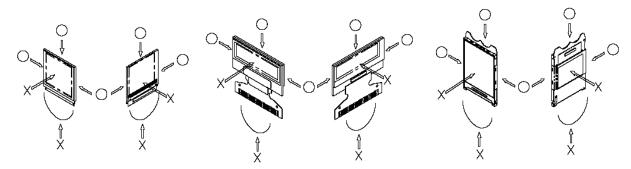
PRECAUTIONS IN USE OF OLED MODULES

MODULES

- 1. Avoid applying excessive shocks to module or making any alterations or modifications to it
- 2. Do not make extra holes on the printed circuit board, modify its shape or change the components of OLED display module
- 3. Do not disassemble the OLED display module
- 4. Do not operate it above the absolute maximum rating
- 5. Do not drop, bend or twist OLED display module
- 6. Soldering: only to the I/O terminals
- 7. Storage: please storage in anti-static electricity container and clean environment
- 8. It is pretty common to use "screen saver" to extend the lifetime and do not use fix information for long time in real application
- 9. Do not use fixed information in OLED panel for long time, that will extend "screen burn" effect time
- 10. Vishay has the right to change the passive components, including R2 and R3 adjust resistors. (Resistors, capacitors, and other passive components will have different appearance and color caused by the different supplier)
- 11. Vishay have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization, and the best product performance... etc, under the premise of not affecting the electrical characteristics and external dimensions, Vishay have the right to modify the version)

HANDLING PRECAUTIONS

- 1. Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position
- 2. If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance
- 3. If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections
- 4. The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module
- 5. When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape
- Scotch mending tape no. 810 or an equivalent
 Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since
 the surface of the polarizer will become cloudy. Also, pay attention that the following liquid and solvent may spoil the
 polarizer:
 - Water
 - Ketone
 - Aromatic solvents
- 6. Hold OLED display module very carefully when placing OLED display module into the system housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases



- 7. Do not apply stress to the LSI chips and the surrounding molded sections
- 8. Do not disassemble nor modify the OLED display module
- 9. Do not apply input signals while the logic power is off

VISHAY.

OLED-020O002A-LPP5N00000

LLD-020002A-Li i 31100000

Vishay

10. Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity

- Be sure to make human body grounding when handling OLED display modules
- Be sure to ground tools to use or assembly such as soldering irons

www.vishay.com

- To suppress generation of static electricity, avoid carrying out assembly work under dry environments
- Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film
- 11. Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above no. 5
- 12. If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above

STORAGE PRECAUTIONS

- 1. When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps and, also, avoiding high temperature and high humidity environment or low temperature (less than 0 °C) environments. We recommend you to store these modules in the packaged state when they were shipped from Vishay. At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them
- 2. If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above

DESIGNING PRECAUTIONS

- 1. The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen
- 2. To prevent occurrence of malfunctioning by noise, pay attention to satisfy the V_{IL} and V_{IH} specifications and, at the same time, to make the signal line cable as short as possible
- 3. We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD) (recommend value: 0.5 A)
- 4. Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices
- 5. As for EMI, take necessary measures on the equipment side basically
- 6. When fastening the OLED display module, fasten the external plastic housing section
- 7. If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module
 - Connection (contact) to any other potential than the above may lead to rupture of the IC

PRECAUTIONS WHEN DISPOSING OF THE OLED DISPLAY MODULES

1. Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations

OTHER PRECAUTIONS

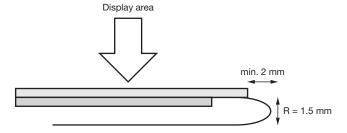
- 1. When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur. Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module
- To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules
 - · Pins and electrodes
 - · Pattern layouts such as the TCP and FPC
- With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur
 - Design the product and installation method so that the OLED driver may be shielded from light in actual usage
 - Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes

VISHAY.

OLED-020O002A-LPP5N00000

www.vishay.com

- 4. Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design
- 5. We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise
- 6. Resistors, capacitors, and other passive components will have different appearance and color caused by the different supplier
- 7. Our company will has the right to upgrade and modify the product function
- 8. The limitation of FPC bending





Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.